

Appl. No. 10/563,778  
Election dated May 21, 2008  
Reply to Restriction Requirement of 04/29/2008  
Attorney Docket No. 1217-053827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/563,778 Confirmation No. 3140  
Applicant : Naoya SAIKI  
Filed : January 6, 2006  
Title : Hardenable Pressure Sensitive Adhesive Sheet for  
Dicing/Die-Bonding and Method for Manufacturing  
Semiconductor Device  
Art Unit : 4191  
Examiner : Christopher C. Caillouet  
Customer No. : 28289

ELECTION AND AMENDMENT

Commissioner of Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated April 29, 2008, please amend the  
above-identified application as follows:

**Election of Claims** begins on page 2 of this paper.

**Amendments to the Specification** begin on page 3 of this paper.

**Remarks** begin on page 5 of this paper.

I hereby certify that this correspondence is being submitted  
electronically in the United States Patent and Trademark  
Office on the date set forth below.

Diane Paull

(Name of Person Mailing Paper)

*Diane Paull*  
Signature

05/21/2008  
Date

### ELECTION

The Examiner required restriction under 35 U.S.C. §121 as follows:

Group I: Claims 1-6 and 8-12, drawn to a pressure-sensitive adhesive sheet; and

Group II: Claims 7 and 13-17, drawn to a process for producing semiconductor devices.

Applicant hereby elects for further prosecution the invention of Group I including claims 1-6 and 8-12, drawn to a pressure-sensitive adhesive sheet.

Applicant reserves the right to file at a later time a divisional application directed to the non-elected process claims.